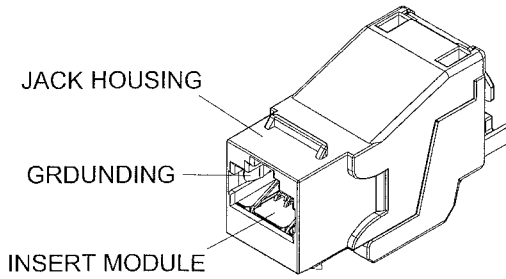
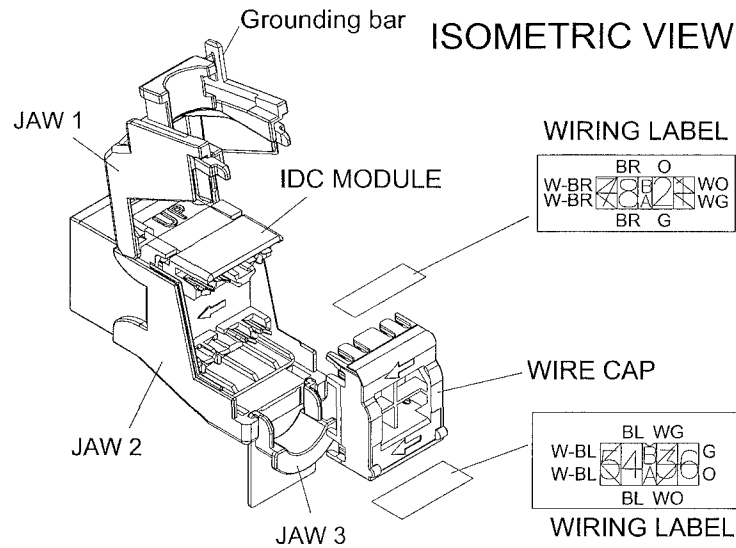


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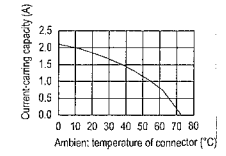
ZONE	REV	DESCRIPTION	DATE	APPV.
-	A	INITIAL RELEASE	07/13/09	E.A.



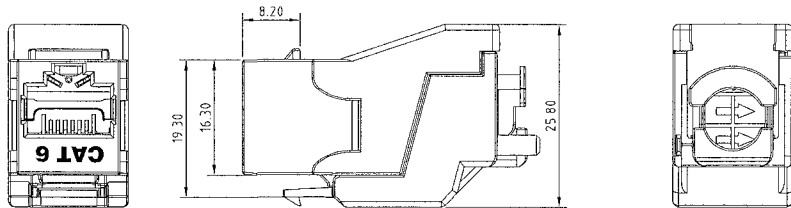
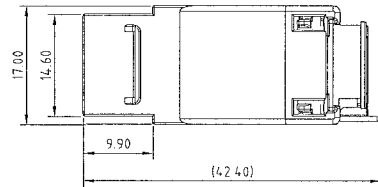
**TRANSMISSION PERFORMANCE**  
Meet TIA/EIA-568-B.2-1 Cat.6 15M Short Link requirements.

**ENVIRONMENTAL CONDITIONS**  
Temperature Range  
Storage -40 to +70°C  
Operation -10 to +60°C  
Relative Humidity (Operational) : Maximum Noncondensing 93%

**ELECTRICAL**  
Electrical Insulation Resistance : 500 MΩ min. @ 100V d.c.  
Dielectric Withstanding Voltage : 1000V d.c. or a.c. Peak Contact to Contact @ 60Hz for 1 minute, 1500V d.c. or a.c. Peak Contact to Panel @ 60Hz for 1 minute  
Spring Wire Contact Resistance : 20 mΩ Max.  
IDC Contact Resistance : 2.5 mΩ Max.  
Current Rating : as figure.



**ASSEMBLY DIMENSION**



COMPONENTS		
ITEM	PART NAME	Q'TY
9	WIRING LABEL	2
8	JAW 3	1
7	JAW 2	1
6	JAW 1	1
5	WIRE CAP	1
4	IDC MODULE	1
3	INSERT MODULE	1
2	GRDUNDING	1
1	JACK HOUSING	1



email....sales@dynacomcorp.com

web....www.dynacomcorp.com

ALL DIMENSIONS ARE IN MILLIMETERS.

NEXT ASSY: -	DRAWN: E.A. 07/13/2009	CHECKED: -	REV. A
TITLE: Cat6 Modular, Toolless Shielded Data Jack		10606FS	